g		GE Industrial	Systems	Functional	Testing Spe	ecification
	Renewal Service Louisville,KY	es		LOU	-GED-193X709	9xx
		Test Procedur	e for a 193X709	AAG01		
DOCUI	MENT REVISION STATUS: D	etermined by the last entry	y in the "REV" and	"DATE" column		
REV.		DESCRIPTION		:	SIGNATURE	REV. DATE
Α	Initial release			S	teve Pharris	8/8/02
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#### Functional test procedure for 193X709AAG01

#### 1. SCOPE

1.1 This is a functional testing procedure for a. 193X709AAG01

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## 2. STANDARDS OF QUALITY

**2.1** Refer to the current revision of the IPC-A-610 standard for workmanship standards.

## 3. APPLICABLE DOCUMENTS

3.1 The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.3.1.1

### 4. ENGINEERING REQUIREMENTS

- 4.1 Equipment Cleaning
  - **4.1.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to the local documented procedures for cleaning guidelines.
- 4.2 Equipment Inspection
  - **4.2.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
    - 4.2.1.1 Wires broken or cracked
    - 4.2.1.2 Terminal strips / connectors broken or cracked
    - **4.2.1.3** Loose wires
    - 4.2.1.4 Components visually damaged
    - 4.2.1.5 Capacitors leaking
    - 4.2.1.6 Solder joints damaged or cold
    - 4.2.1.7 Circuit board burned or de-laminated
    - 4.2.1.8 Printed wire runs burned or damaged

### 5. EQUIPMENT REQUIRED

**5.1** The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1		Fluke 85 DMM (or Equivalent)
1		Rainbow Box
2		10K Ohm Resistors
1		193X Connector Box
2		Power Supplies

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### 6. <u>TESTING PROCESS</u>

- 6.1 Setup
  - **6.1.1** Place Resistors in connectors on top of rainbow box.
  - **6.1.2** Set power supply 1 for 20VDC.
  - **6.1.3** Set power supply 2 for 10VDC.
  - **6.1.4** Make all connections as per wiring diagram.
- **6.2** Testing Procedure
  - **6.2.1** Place all switches left.
  - **6.2.2** Insert card and energize both power supplies.
  - **6.2.3** Move switch 1 to the right. DVM should read less than 50mVDC.
  - 6.2.4 Move switch 1 to the left and switch 2 to the right and reverse the leads on power supply 2 so that a negative voltage is produced. DVM should read 10VDC.
  - **6.2.5** Move switch 2 to the left. DVM should read +10VDC.
  - **6.2.6** Move switch 2 to the right and reverse the leads to power supply 2 so that a positive voltage is produced. DVM should read +10VDC.
  - **6.2.7** Move switch 2 to the left. DVM should read –10VDC.
  - **6.2.8** Turn off power supplies.
- 6.3 \*\*\*TEST COMPLETE \*\*\*

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# 7. NOTES

